# INTEGRATED CIRCUITS



Product specification IC23 Data Handbook 1995 Sep 22



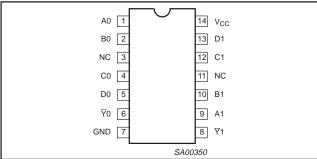
Philips Semiconductors

# 74ABT20

## QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^{\circ}C;$ GND = 0V	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn, Cn, Dn to Ƴn	C <sub>L</sub> = 50pF; V <sub>CC</sub> = 5V	2.7 2.2	ns
t <sub>OSLH</sub> t <sub>OSHL</sub>	Output to Output skew		0.3	ns
C <sub>IN</sub>	Input capacitance	$V_I = 0V \text{ or } V_{CC}$	3	pF
Icc	Total supply current	Outputs disabled; $V_{CC} = 5.5V$	50	μΑ

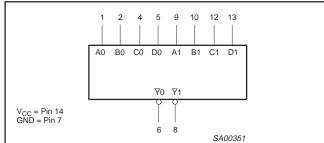
## **PIN CONFIGURATION**



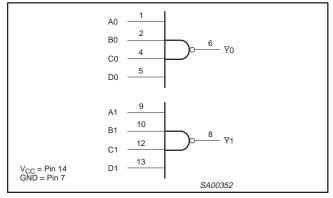
## **PIN DESCRIPTION**

PIN NUMBER	SYMBOL NAME AND FUNCTION	
1, 2, 4, 5, 9, 10, 12, 13	An, Bn, Cn, Dn	Data inputs
6, 8	₹	Data outputs
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive supply voltage

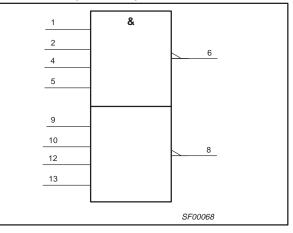
## LOGIC SYMBOL



## LOGIC DIAGRAM



## LOGIC SYMBOL (IEEE/IEC)



## **FUNCTION TABLE**

	INPUTS							
An	Bn	Cn	Dn	₹n				
L	Х	Х	Х	Н				
Х	L	Х	Х	Н				
Х	Х	L	Х	Н				
Х	Х	Х	L	Н				
Н	Н	Н	Н	L				

NOTES:

H = High voltage level L = Low voltage level

X = Don't care

## **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic DIP	–40°C to +85°C	74ABT20 N	74ABT20 N	SOT27-1
14-Pin plastic SO	-40°C to +85°C	74ABT20 D	74ABT20 D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +85°C	74ABT20 DB	74ABT20 DB	SOT337-1
14-Pin Plastic TSSOP Type I	–40°C to +85°C	74ABT20 PW	74ABT20PW DH	SOT402-1

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### **ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>**

SYMBOL	PARAMETER	PARAMETER CONDITIONS			
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V	
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	-18	mA	
VI	DC input voltage <sup>3</sup>		-1.2 to +7.0	V	
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < 0	-50	mA	
V <sub>OUT</sub>	DC output voltage <sup>3</sup>	output in Off or High state	-0.5 to +5.5	V	
I <sub>OUT</sub>	DC output current	output in Low state	40	mA	
T <sub>stg</sub>	Storage temperature range		-65 to 150	°C	

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIM	MAX         UNIT           5.5         V           V <sub>CC</sub> V           0.8         V	LINIT
STMBOL		MIN	MAX	
V <sub>CC</sub>	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V <sub>CC</sub>	V
V <sub>IH</sub>	High-level input voltage	2.0		V
V <sub>IL</sub>	Low-level input voltage		0.8	V
I <sub>OH</sub>	High-level output current		-15	mA
I <sub>OL</sub>	Low-level output current		20	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T <sub>amb</sub>	Operating free-air temperature range	-40	+85	°C

## DC ELECTRICAL CHARACTERISTICS

					LIMITS	_	IN         MAX $-1.2$ $1$ $5$ $1$ $5$ $1$ $\pm 1.0$ $\mu$ $\pm 100$ $\mu$ $50$ $-180$		
SYMBOL	PARAMETER	TEST CONDITIONS	Ta	<sub>mb</sub> = +25	j∘C	T <sub>amb</sub> =	to +85°C           MIN         MAX           -1.2         2.5           0.5         1           ±1.0         ±100           50         50		
			MIN	TYP	MAX	MIN	MAX	1	
V <sub>IK</sub>	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$		-0.9	-1.2		-1.2	V	
V <sub>OH</sub>	High-level output voltage	$V_{CC}$ = 4.5V; $I_{OH}$ = -15mA; $V_I$ = $V_{IL}$ or $V_{IH}$	2.5	2.9		2.5		V	
V <sub>OL</sub>	Low-level output voltage	$V_{CC}$ = 4.5V; $I_{OL}$ = 20mA; $V_I$ = $V_{IL}$ or $V_{IH}$		0.35	0.5		0.5	V	
l <sub>l</sub>	Input leakage current	$V_{CC} = 5.5V; V_{I} = GND \text{ or } 5.5V$		±0.01	±1.0		±1.0	μA	
I <sub>OFF</sub>	Power-off leakage current	$V_{CC}$ = 0.0V; $V_O$ or $V_1 \le 4.5V$		±5.0	±100		±100	μA	
I <sub>CEX</sub>	Output High leakage current	$V_{CC}$ = 5.5V; $V_{O}$ = 5.5V; $V_{I}$ = GND or $V_{CC}$		5.0	50		50	μA	
Ι <sub>Ο</sub>	Output current <sup>1</sup>	$V_{CC} = 5.5 V; V_{O} = 2.5 V$	-50	-75	-180	-50	-180	mA	
I <sub>CC</sub>	Quiescent supply current	$V_{CC}$ = 5.5V; $V_{I}$ = GND or $V_{CC}$		2	50		50	μA	
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC}$ = 5.5V; One data input at 3.4V, other inputs at $V_{CC}$ or GND		0.25	500		500	μΑ	

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

2. This is the increase in supply current for each input at 3.4V.

3. For valid test results, data must not be loaded into the flip-flop or latch after applying the power.

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## **AC CHARACTERISTICS**

GND = 0V;  $t_R = t_F = 2.5$ ns;  $C_L = 50$ pF,  $R_L = 500\Omega$ 

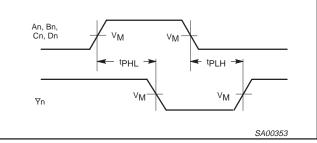
					LIMIT	S		UNIT
SYMBOL	PARAMETER	WAVEFORM	$ \begin{array}{ c c c } T_{amb} = +25^{\circ}C & T_{amb} = -40^{\circ}C \ to \ +85^{\circ}C \\ V_{CC} = +5.0V & V_{CC} = +5.0V \ \pm 0.5V \\ \end{array} $		°C to +85°C .0V ±0.5V	UNIT		
			MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn, Cn, Dn to Yn	1	1.0 1.0	2.7 2.2	3.9 3.4	1.0 1.0	4.6 3.8	ns
<sup>t</sup> OSHL tOSLH <sup>1</sup>	Output to Output skew An or Bn to ∀n	2		0.3	0.5		0.5	ns

NOTE:

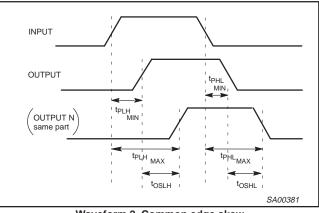
 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the the same direction, either HIGH–to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

## AC WAVEFORMS

 $V_{M} = 1.5V, V_{IN} = GND \text{ to } 3.0V$ 

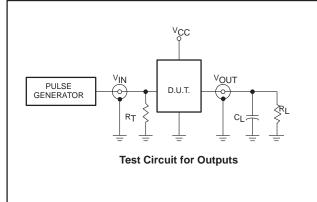


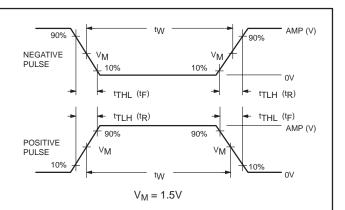
Waveform 1. Propagation Delay for Inverting Outputs



Waveform 2. Common edge skew

## **TEST CIRCUIT AND WAVEFORMS**



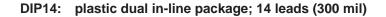


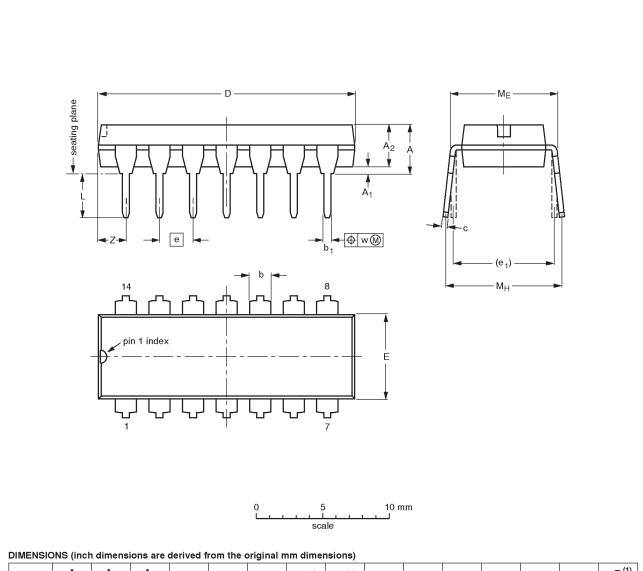
### Input Pulse Definition

# DEFINITIONS

- R<sub>L</sub> = Load resistor; see AC CHARACTERISTICS for value.
- $C_L$  = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
- $\label{eq:RT} \mathsf{R}_{\mathsf{T}} = \quad \text{Termination resistance should be equal to } \mathsf{Z}_{\mathsf{OUT}} \text{ of } \\ \text{pulse generators.}$

FAMILY	IN	PUT PULSE R	EQUIRE	MENTS	
	Amplitude	Rep. Rate	t <sub>W</sub>	t <sub>R</sub>	t <sub>F</sub>
74ABT	3.0V	1MHz	500ns	2.5ns	2.5ns
					SH00067





UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	ME	м <sub>н</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

### Note

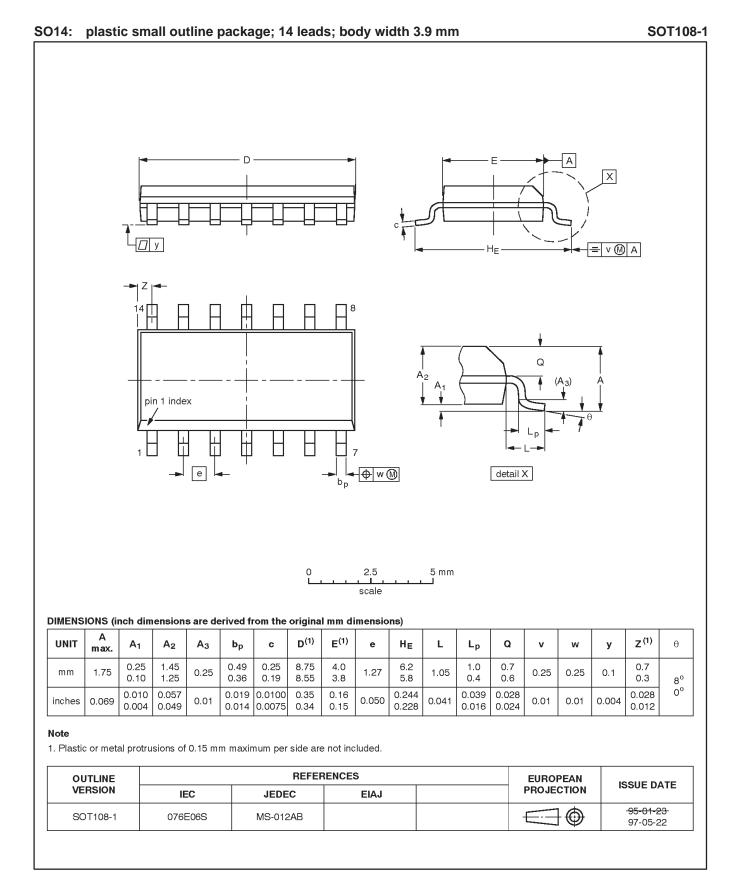
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES				
VERSION	IEC	IEC JEDEC EIAJ		PROJECTION	ISSUE DATE		
SOT27-1	050G04	MO-001AA			<del>-92-11-17</del> 95-03-11		

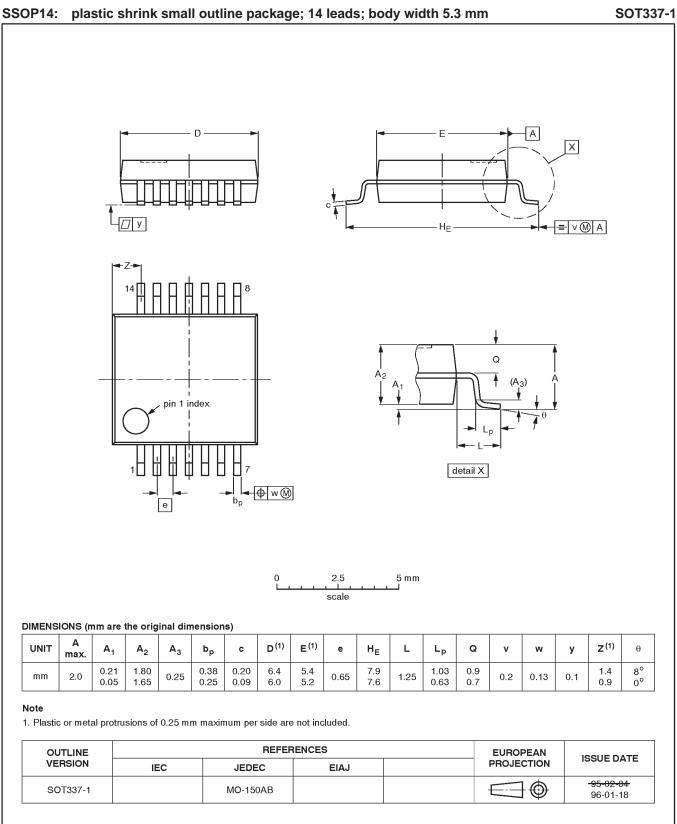
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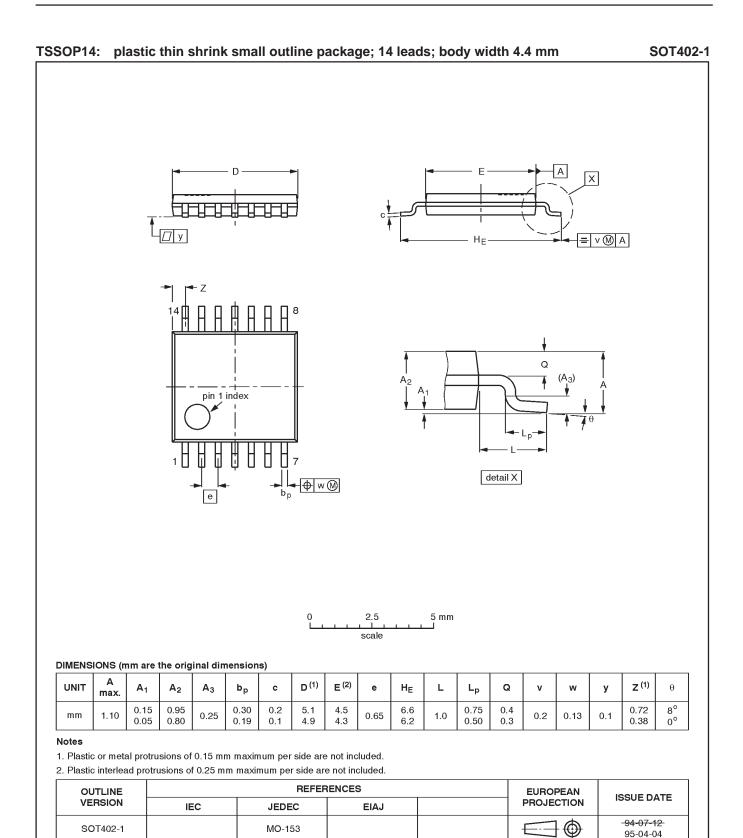
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NOTES

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DEFINITIONS						
Data Sheet Identification	Product Status	Definition				
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.				
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.				
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